L Number	Hits	Search Text	DB	Time stamp
1	2	"20020050632"	USPAT;	2004/03/29 11:53
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	000440040044.50
2	252	\$3Fe?sub.2O?sub.4	USPAT;	2004/03/29 11:58
			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM_TDB	
3	11514	((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite	USPAT;	2004/03/29 12:21
		chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4")) near12	US-PGPUB;	
		(shield\$3 PWB PCB carrier substrate (lead adj frame)	EPO; JPO;	
		interposer (printed adj2 (circuit wiring)))	DERWENT;	
			IBM_TDB	
4	2046	(((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4	USPAT;	2004/03/29 12:16
:		manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))	US-PGPUB;	
		near12 (shield\$3 PWB PCB carrier substrate (lead adj frame)	EPO; JPO;	
		interposer (printed adj2 (circuit wiring)))) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"	DERWENT;	
		dielectric 5iO2 5iiv 5i5iv4 5iO.sub.2 5i.sub.3iv.sub.4	IBM_TDB	
5	1675	((((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4	USPAT;	2004/03/29 12:16
	10.0	manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))	US-PGPUB;	200 1700720 12:10
	!	near12 (shield\$3 PWB PCB carrier substrate (lead adj frame)	EPO; JPO;	
		interposer (printed adj2 (circuit wiring)))) same (insulat\$3	DERWENT;	,
	•	dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"	IBM_TDB	
		("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831		
6	9957	((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite	USPAT;	2004/03/29 12:22
		chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4")) near12 (PWB	US-PGPUB;	
		PCB carrier substrate (lead adj frame) interposer (printed	EPO; JPO;	
		adj2 (circuit wiring))))	DERWENT;	
7	1736	(((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4	IBM_TDB USPAT;	2004/03/29 12:16
'	1700	manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))	US-PGPUB;	2004/00/20 12.10
		near12 (PWB PCB carrier substrate (lead adj frame)	EPO; JPO;	
		interposer (printed adj2 (circuit wiring)))) same (insulat\$3	DERWENT;	
		dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"	IBM_TDB	
		("Si.sub.3" adj "N.sub.4") polyimide)		
8	1441	((((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4	USPAT;	2004/03/29 12:17
		manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))	US-PGPUB;	
		near12 (PWB PCB carrier substrate (lead adj frame)	EPO; JPO;	
		interposer (printed adj2 (circuit wiring)))) same (insulat\$3 dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"	DERWENT; IBM_TDB	
		("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831	1014-100	
9	237	((((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4	USPAT;	2004/03/29 12:17
		manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))	US-PGPUB;	
		near12 (PWB PCB carrier substrate (lead adj frame)	EPO; JPO;	
		interposer (printed adj2 (circuit wiring)))) same (insulat\$3	DERWENT;	
		dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"	IBM_TDB	
10	4 4 7 4	("Si.sub.3" adj "N.sub.4") polyimide)) and @rlad<20000831	LICDAT	2004/02/20 40:47
10	1474	(((((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))	USPAT; US-PGPUB;	2004/03/29 12:17
		near12 (PWB PCB carrier substrate (lead adj frame)	EPO; JPO;	
		interposer (printed adj2 (circuit wiring)))) same (insulat\$3	DERWENT:	
		dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"	IBM TDB	
		("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831)	_	
		(((((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4	1	
		manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))		
		near12 (PWB PCB carrier substrate (lead adj frame)		
		interposer (printed adj2 (circuit wiring)))) same (insulat\$3		
]		dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4" ("Si.sub.3" adj "N.sub.4") polyimide)) and @rlad<20000831)		
		(Olisabis auj 14.5abi4) polyimide) j and @nad<20000831)	l	

11	1784	((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite	USPAT;	2004/03/29 12:18
		chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4")) near12	US-PGPUB;	
		shield\$3	EPO; JPO; DERWENT:	
			IBM TDB	
12	70	((((((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4	USPAT;	2004/03/29 12:18
		manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))	US-PGPUB;	
		near12 (PWB PCB carrier substrate (lead adj frame)	EPO; JPO;	
		interposer (printed adj2 (circuit wiring)))) same (insulat\$3	DERWENT;	
		dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"	IBM_TDB	
		("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831)		
		(((((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4 manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))		
		near12 (PWB PCB carrier substrate (lead adj frame)		
		interposer (printed adj2 (circuit wiring)))) same (insulat\$3		
		dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"		
		("Si.sub.3" adj "N.sub.4") polyimide)) and @rlad<20000831))		
		and (((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4		
		manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))		
40	45	near12 shield\$3)	LIODAT	0004/00/00 40:00
13	45	(((((((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4	USPAT;	2004/03/29 12:22
	1	manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4")) near12 (PWB PCB carrier substrate (lead adj frame)	US-PGPUB; EPO; JPO;	
	/·	interposer (printed adj2 (circuit wiring)))) same (insulat\$3	DERWENT;	
		dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"	IBM TDB	
	/	("Si.sub.3" adj "N.sub.4") polyimide)) and @ad<20000831)		
	1/	(((((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4		
	/	manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))		
	, l	near12 (PWB PCB carrier substrate (lead adj frame)		
	1	interposer (printed adj2 (circuit wiring)))) same (insulat\$3		
	11	dielectric SiO2 SiN Si3N4 "SiO.sub.2" "Si.sub.3N.sub.4"		
	11	("Si.sub.3" adj "N.sub.4") polyimide)) and @rlad<20000831)) and (((magnetic adj oxide) ferrite \$3Fe?sub.2O?sub.4		
	11	manganite chromite cobaltite (\$3Fe?sub.2 adj "O.sub.4"))	1	
		near12 shield\$3)) and (circuit chip die semiconductor)		